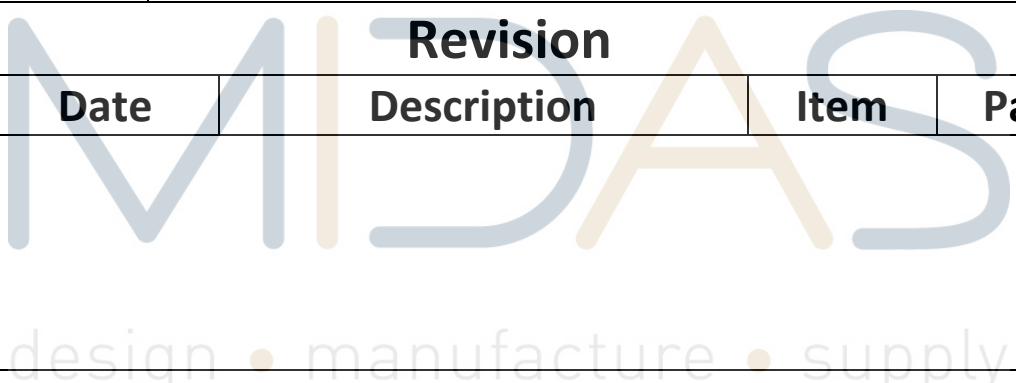


| Specification | | | | |
|---|-------------|--------------------|-------------|-------------|
| Part Number: | | | | |
| Version: | | | | |
| Date: | | | | |
| Revision | | | | |
| No. | Date | Description | Item | Page |
|  | | | | |

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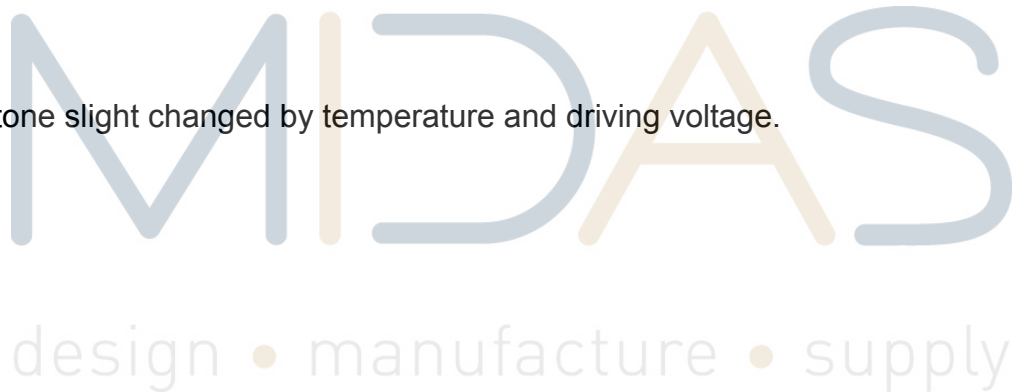
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2. General Specification

- Resolution: 320 x RGBx240
- Module dimension: 160.0 x 109.0 x 7.0 mm
- Active Area : 115.2 x 86.4mm
- Dot pitch: 0.36 x 0.36 mm
- LCD type: TFT, Positive, Transmissive
- View direction: 12 o'clock
- Gray Scale Inversion Direction: 6 o'clock
- Backlight Type: LED, Normally White

*Color tone slight changed by temperature and driving voltage.



Midas Active Matrix Display Part Number System

MC T 057 A 6 * W 320240 L M L * * * * *

1 2 3 4 5 6 7 8 9 10 11 12 13 14 15 16

- 1 = MC: Midas Components
- 2 = T: TFTA: Active Matrix OLED
- 3 = Size
- 4 = Series
- 5 = Viewing Angle: 6: 6 O'clock 12: 12 O'clock
- 6 = Blank: No Touch T: Resistive Touchscreen C: Capacitive Touchscreen
- 7 = Operating Temp Range: S: 0 to 50Deg C B: -20+60Deg C
W: -20+70Deg C E: -30+85Deg C
- 8 = No of Pixels
- 9 = Orientation: P: Portrait L: Landscape
- 10 = Mode: R: Reflective M: Transmissive T: Transflective
S: Sunlight Readable (transmissive)
W: White on Black (Monochrome)
- 11 = Backlight: Blank: None L: LED C: CCFL
- 12 = Blank: No Module/board C: Controller board module
- 13 = Blank: None V: Video
- 14 = Blank: None B: Bracket
- 15 = Blank: None H: Host Cable
- 16 = Blank: None K: Keyboard

4. Interface Pin Function

4.1. LCM PIN Definition

| Pin | Symbol | Function | Remark |
|-----|--------------|----------------------|--------|
| 1 | GND | System ground | |
| 2 | VDD | Power Supply : +3.3V | |
| 3 | NC | No connect | |
| 4 | A0 | Data/Command select | |
| 5 | /WR(R/W) | Write strobe signal | |
| 6 | /RD(E) | Read strobe signal | |
| 7 | DB0 | Data bus | |
| 8 | DB1 | Data bus | |
| 9 | DB2 | Data bus | |
| 10 | DB3 | Data bus | |
| 11 | DB4 | Data bus | |
| 12 | DB5 | Data bus | |
| 13 | DB6 | Data bus | |
| 14 | DB7 | Data bus | |
| 15 | /CS | Chip select | |
| 16 | /RESET(RSTB) | Hardware reset | |
| 17 | IF0 | Mode select | Note1 |
| 18 | IF1 | | |
| 19 | NC | No connect | |
| 20 | NC | No connect | |
| 21 | NC | No connect | |
| 22 | NC | No connect | |

Note1:

| Setting | | MCU Type | Interface Pin Function | | | | |
|---------|-----|--------------------------|------------------------|----|-----|-------------------------------------|--------|
| IF1 | IF0 | | CSB | A0 | RWR | ERD | D[7:0] |
| L | L | Parallel 8080 series MCU | CSB | A0 | /WR | /RD | D[7:0] |
| L | H | Parallel 6800 series MCU | | | R/W | E | D[7:0] |
| H | H | Serial 4-Line series MCU | | - | - | D7=SCL, D0=SDA, D[6:1] are not used | |
| H | L | Serial 3-Line series MCU | | - | - | | |

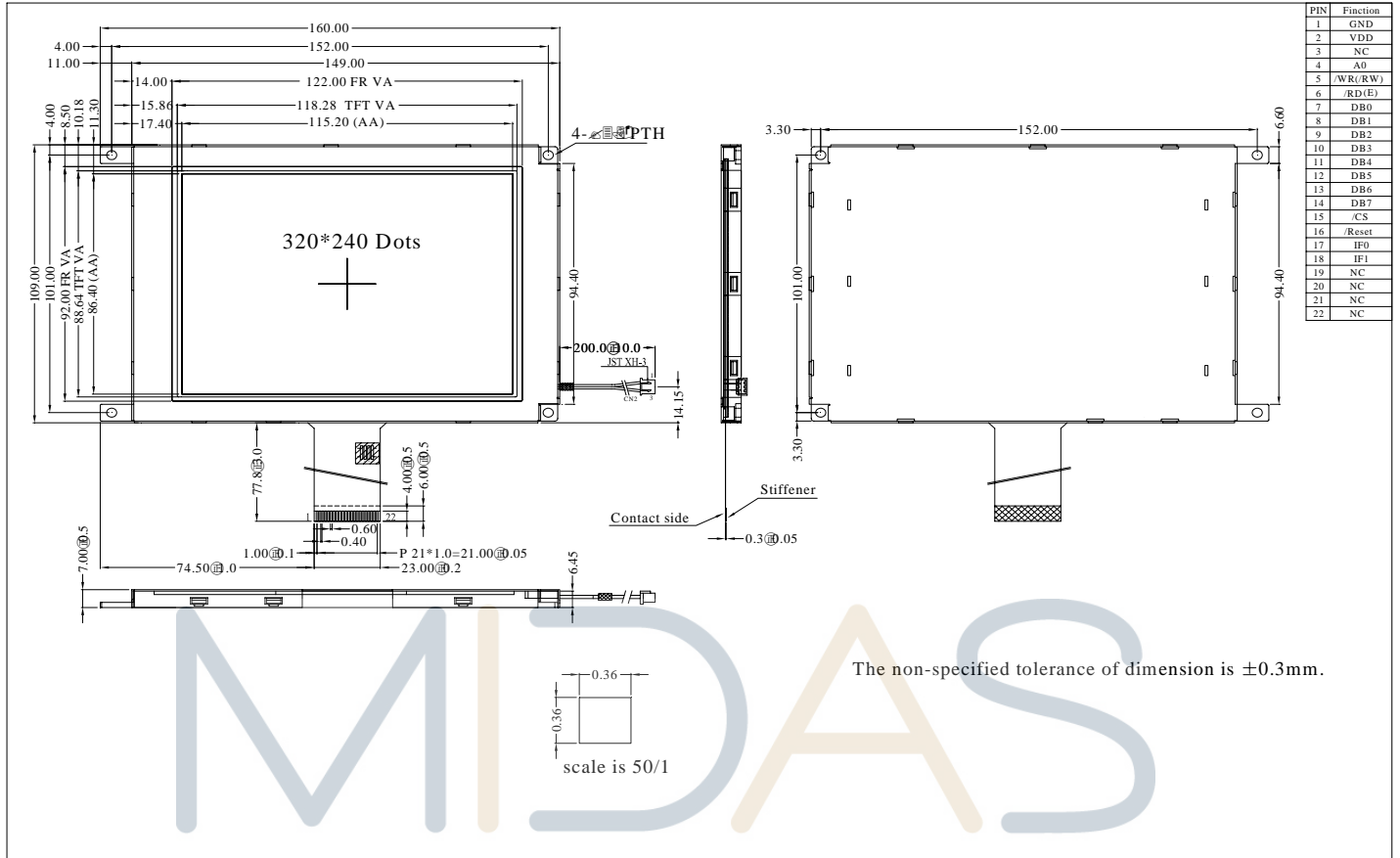
The un-used pins are marked as “-” and should be connected to “H” by VDDI.

4.2. Backlight Unit Section(CN2)

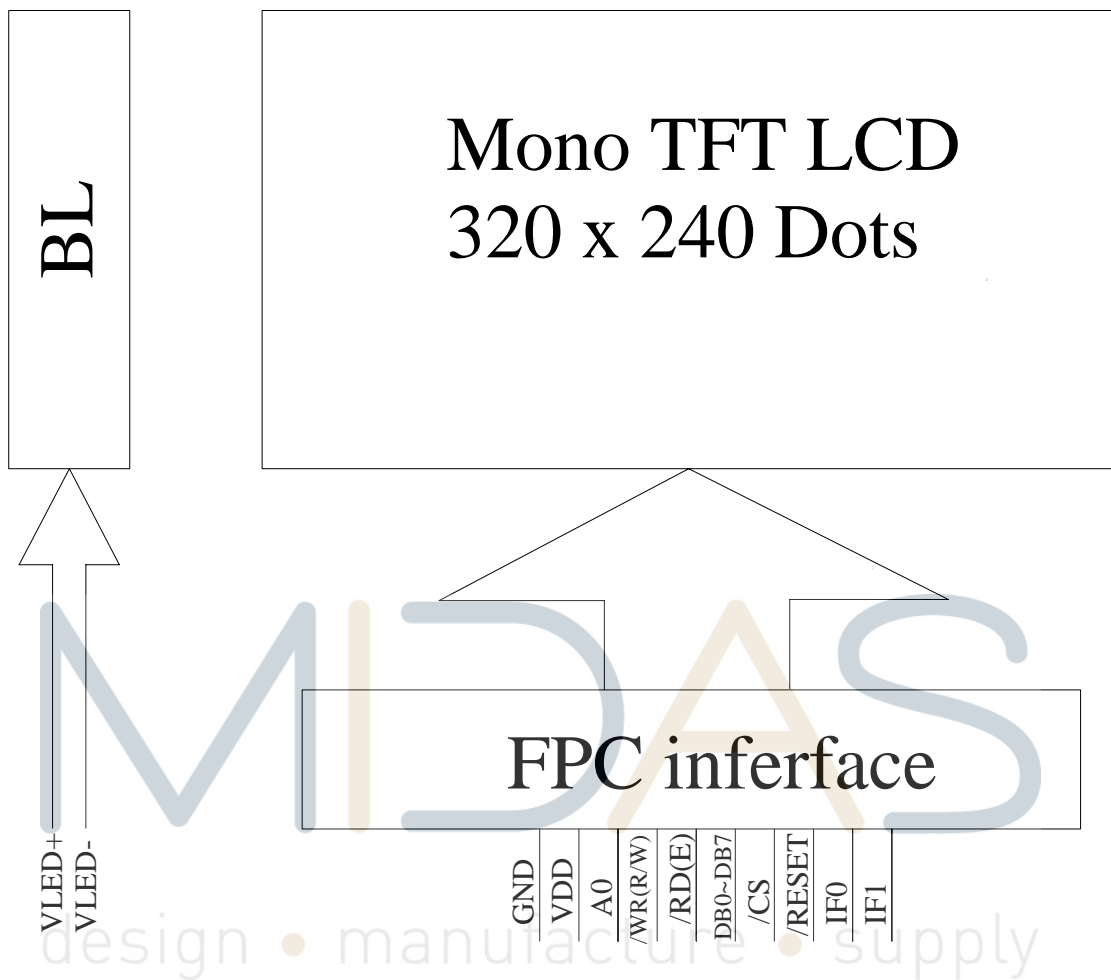
LED Light Bar connector is used for the the integral backlight system. The recommended model is “JST XH-3” manufactured by JST.

| Pin No. | Symbol | I/O | Function | Remark |
|---------|-------------------|-----|-------------------------------------|--------|
| 1 | V _{LED+} | P | Power for LED backlight anode (A) | Red |
| 3 | V _{LED-} | P | Power for LED backlight cathode (K) | White |

5. Contour Drawing



6. Block Diagram

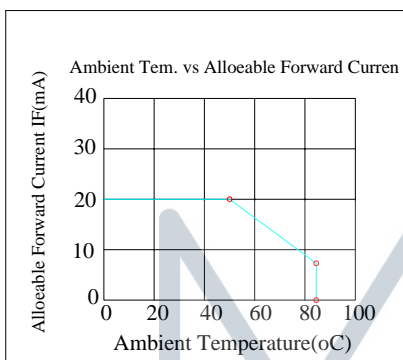


7. Absolute Maximum Ratings

| Item | Symbol | Min | Typ | Max | Unit |
|-----------------------|--------|-----|-----|-----|------|
| Operating Temperature | TOP | -20 | — | +70 | °C |
| Storage Temperature | TST | -30 | — | +80 | °C |

Note: Device is subject to be damaged permanently if stresses beyond those absolute maximum ratings listed above

1. Temp. $\leq 60^{\circ}\text{C}$, 90% RH MAX. Temp. $> 60^{\circ}\text{C}$, Absolute humidity shall be less than 90% RH at 60°C



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8. Electrical Characteristics

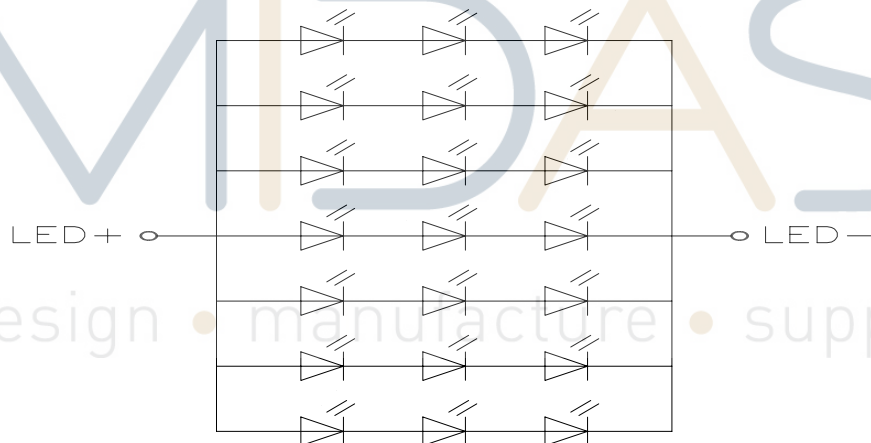
8.1. Operating conditions:

| Item | Symbol | Condition | Min | Typ | Max | Unit | Remark |
|------------------------|--------|-----------|-----|-----|-----|------|--------|
| Supply Voltage For LCM | VDD | — | 3.0 | 3.3 | 3.6 | V | |
| Supply Current For LCM | IDD | — | — | 20 | 30 | mA | Note1 |
| Power Consumption | — | — | — | 66 | 108 | mW | |

Note1: This value is test for VDD=3.3V only

8.2. LED driving conditions

| Parameter | Symbol | Min. | Typ. | Max. | Unit | Remark |
|-------------------|--------|------|--------|------|------|------------|
| LED current | | - | 140 | - | mA | |
| Power Consumption | | 1120 | - | 1386 | mW | |
| LED voltage | VLED+ | 8.0 | 9.0 | 9.9 | V | Note 1 |
| LED Life Time | | - | 50,000 | - | Hr | Note 2,3,4 |



Note 1 : Power supply the back light specification

Note 2 : Ta = 25 °C

Note 3 : Brightness to be decreased to 50% of the initial value

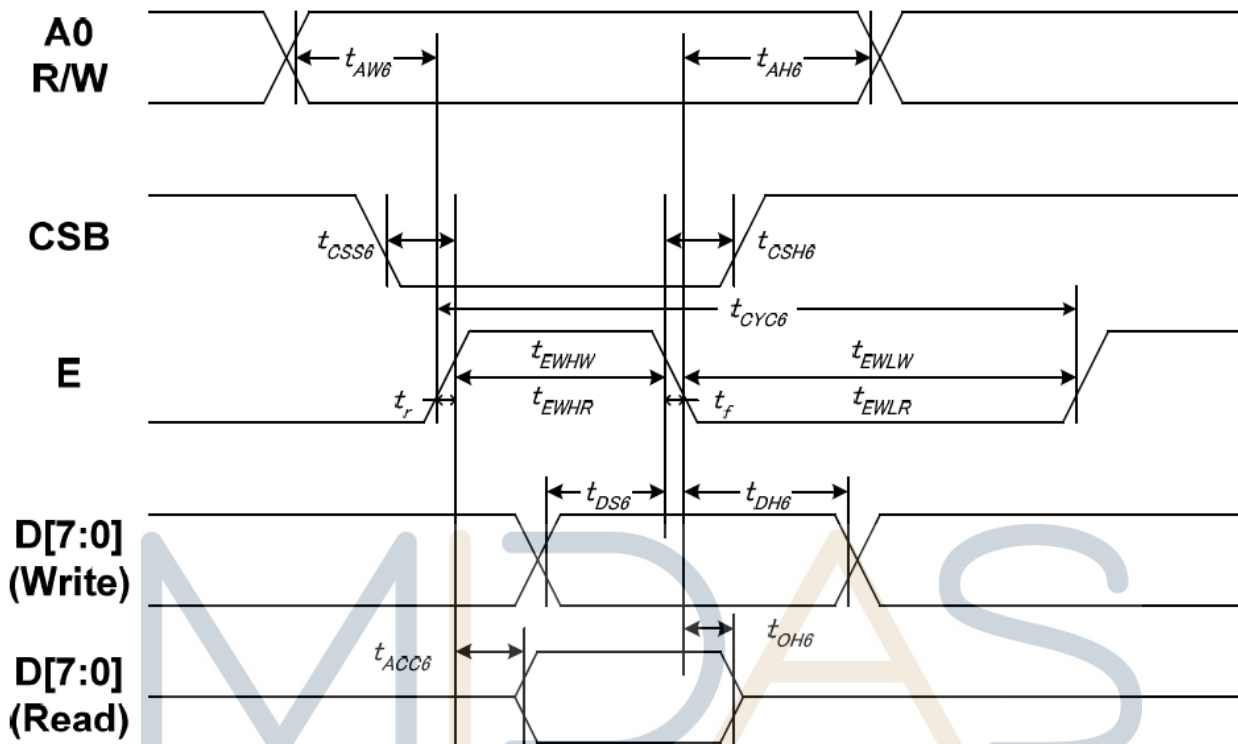
Note 4 : The single LED lamp case

9. DC CHARACTERISTICS

| Parameter | Symbol | Rating | | | Unit | Condition |
|--------------------------|-----------------|--------|-----|--------|------|-----------|
| | | Min | Typ | Max | | |
| Low level input voltage | V _{IL} | 0 | - | 0.3VDD | V | |
| High level input voltage | V _{IH} | 0.7VDD | - | VDD | V | |

10.AC Characteristics

10.1. System Bus Timing for 6800 Series MPU

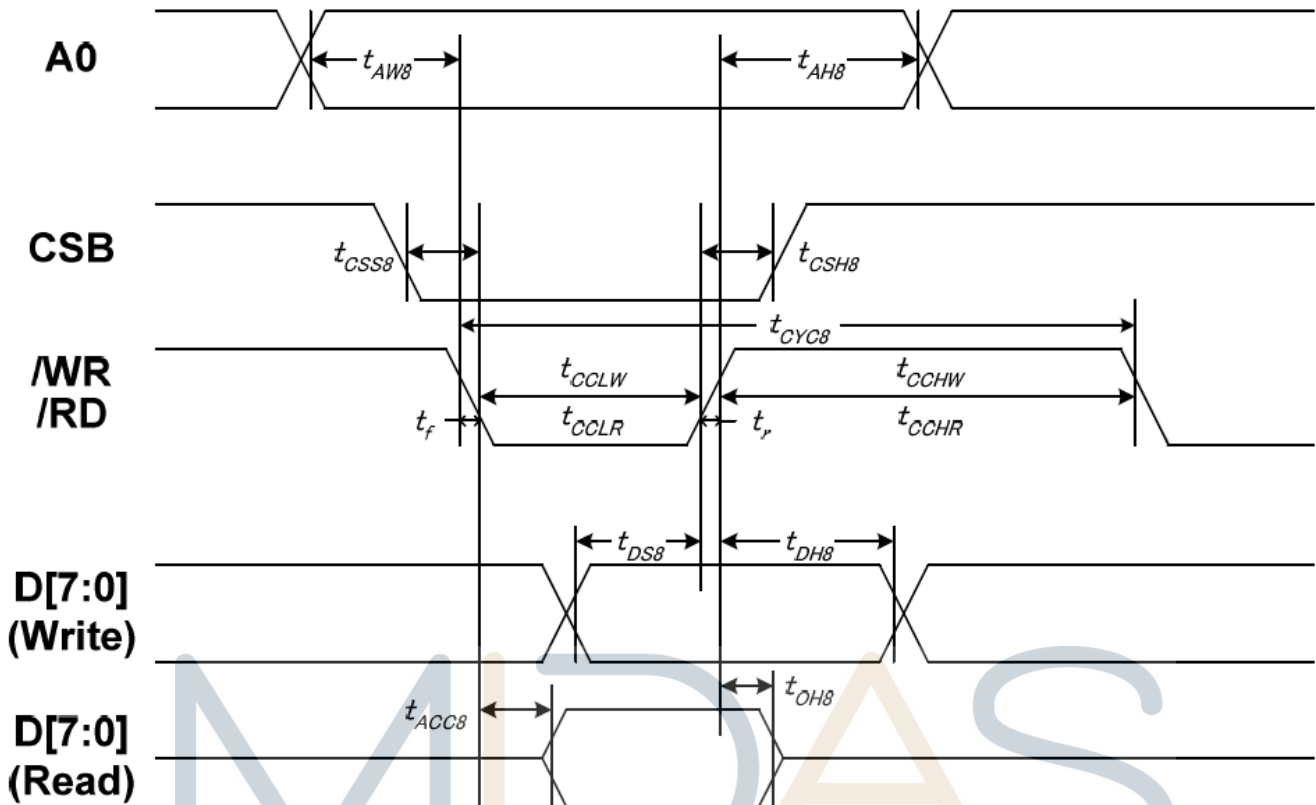


| Item | Signal | Symbol | Condition | Min | Max | Unit |
|-------------------------------|--------|--------|-------------|-----|-----|------|
| Address setup time | A0 | tAW6 | - | 10 | - | ns |
| Address hold time | A0 | tAH6 | - | 0 | - | |
| System cycle time | | tCYC6 | - | 200 | - | |
| Enable L pulse width (WRITE) | E | tEHLW | - | 100 | - | |
| Enable H pulse width (WRITE) | E | tEHWL | - | 100 | - | |
| Enable L pulse width (READ) | E | tEHLR | - | 130 | - | |
| Enable H pulse width (READ) | E | tEWHR | - | 130 | - | |
| CSB setup time | CSB | tCSS6 | - | 100 | - | |
| CSB hold time | CSB | tCSH6 | - | 100 | - | |
| Write data setup time | D[7:0] | tDS6 | - | 70 | - | |
| Write data hold time | | tDH6 | - | 20 | - | |
| Read data access time | D[7:0] | tACC6 | CL = 100 pF | - | 80 | |
| Read data output disable time | | tOH6 | CL = 100 pF | 15 | 80 | |

Note:

1. The input signal rise time and fall time (t_r , t_f) is specified at 15 ns or less. When the system cycle time is extremely fast, $(t_r + t_f) \leq (t_{CYC6} - t_{CCLW} - t_{CCHW})$ for $(t_r + t_f) \leq (t_{CYC6} - t_{CCLR} - t_{CCHR})$ are specified.
2. All timing is specified using 20% and 80% of VDDI as the reference.
3. t_{CCLW} and t_{CCLR} are specified as the overlap between CSB being "L" and /WR and /RD being at the "L" level. CSB and /WR (or /RD) cannot act at the same time and CSB should be 100ns wider than /WR (or /RD).

10.2. System Bus Timing for 8080 Series MPU

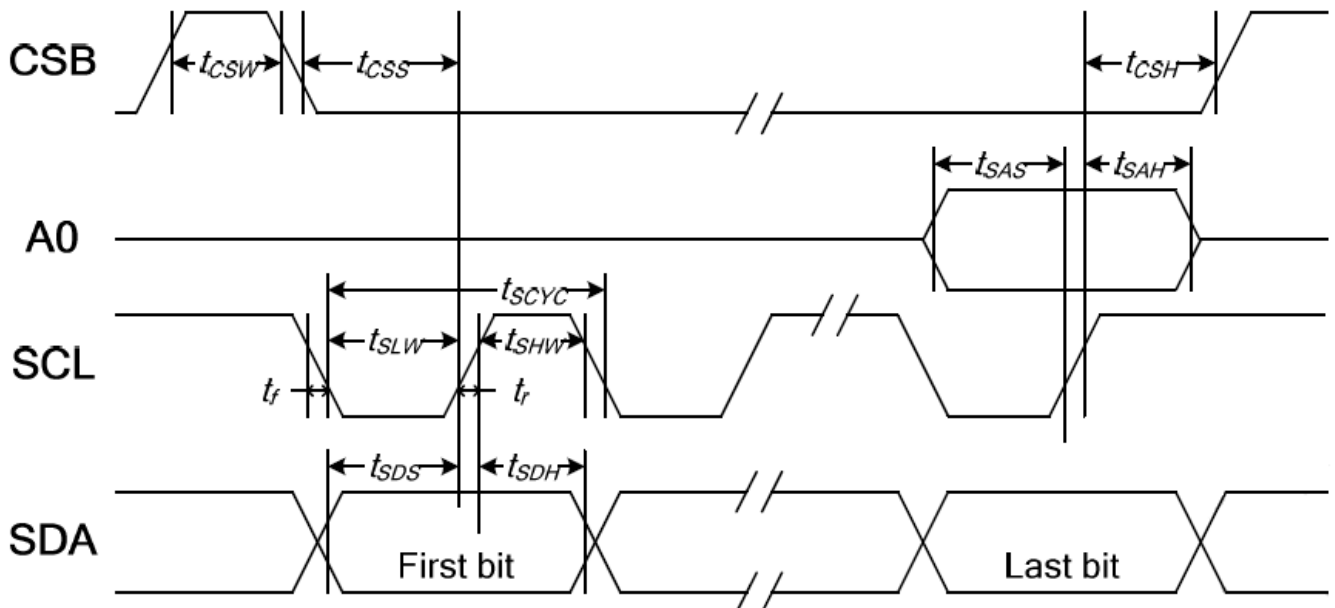


| Item | Signal | Symbol | Condition | Min | Max | Unit |
|-------------------------------|--------|--------|-------------|-----|-----|------|
| Address setup time | A0 | tAW8 | - | 10 | - | ns |
| Address hold time | | tAH8 | - | 0 | - | |
| System cycle time | | tCYC8 | - | 200 | - | |
| /WR L pulse width (WRITE) | /WR | tCCLW | - | 100 | - | |
| /WR H pulse width (WRITE) | | tCCHW | - | 100 | - | |
| /RD L pulse width (READ) | /RD | tCCLR | - | 120 | - | |
| /RD H pulse width (READ) | | tCCHR | - | 120 | - | |
| CSB setup time | CSB | tCSS8 | - | 100 | - | |
| CSB hold time | | tCSH8 | - | 100 | - | |
| Write data setup time | D[7:0] | tDS8 | - | 70 | - | |
| Write data hold time | | tDH8 | - | 20 | - | |
| Read data access time | | tACC8 | CL = 100 pF | - | 80 | |
| Read data output disable time | | tOH8 | CL = 100 pF | 15 | 80 | |

Note:

1. The input signal rise time and fall time (t_r , t_f) is specified at 15 ns or less. When the system cycle time is extremely fast, $(t_r + t_f) \leq (t_{CYC8} - t_{CCLW} - t_{CCHW})$ for $(t_r + t_f) \leq (t_{CYC8} - t_{CCLR} - t_{CCHR})$ are specified.
2. All timing is specified using 20% and 80% of VDDI as the reference.
3. tCCLW and tCCLR are specified as the overlap between CSB being "L" and /WR and /RD being at the "L" level. CSB and /WR (or /RD) cannot act at the same time and CSB should be 100ns wider than /WR (or /RD).

10.3. System Bus Timing for 4-Line Serial Interface

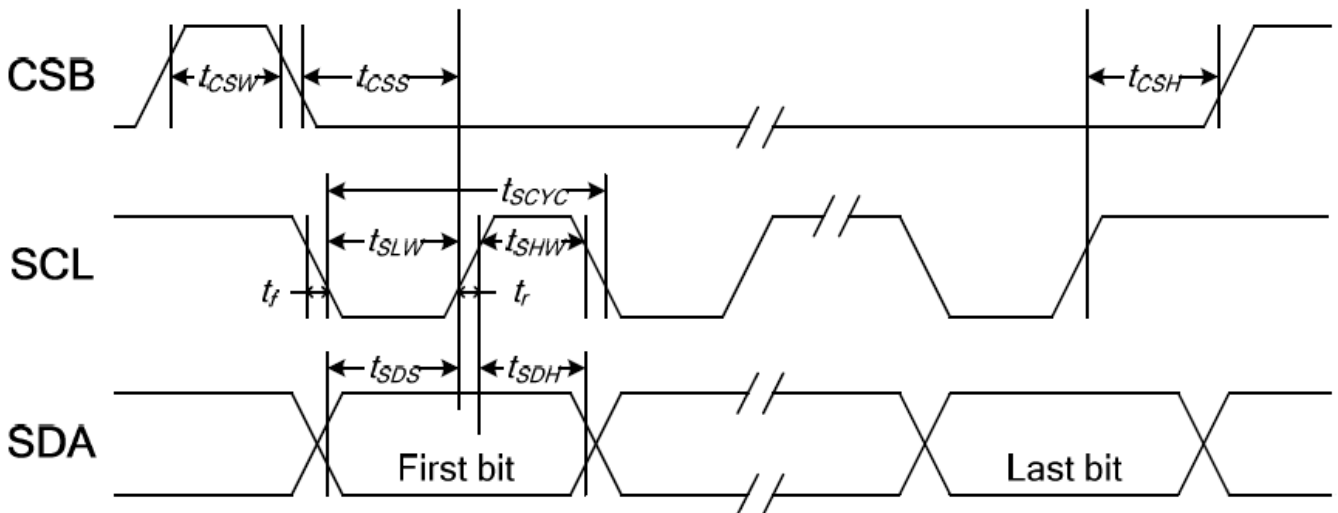


| Item | Signal | Symbol | Condition | Min | Max | Unit |
|---------------------|--------|--------|-----------|-----|-----|------|
| Serial clock period | | tSCYC | - | 80 | - | ns |
| SCL "H" pulse width | SCL | tSHW | - | 40 | - | |
| SCL "L" pulse width | SCL | tSLW | - | 40 | - | |
| Address setup time | A0 | tSAS | - | 40 | - | |
| Address hold time | A0 | tSAH | - | 40 | - | |
| Data setup time | SDA | tSDS | - | 15 | - | |
| Data hold time | SDA | tSDH | - | 20 | - | |
| CSB-SCL time | | tCSS | - | 40 | - | |
| CSB-SCL time | CSB | tCSH | - | 40 | - | |
| CSB "H" pulse width | CSB | tCSW | - | 15 | - | |

Note:

1. The input signal rise and fall time (t_r , t_f) are specified at 15 ns or less.
2. All timing is specified using 20% and 80% of VDDI as the standard.

10.4. System Bus Timing for 3-Line Serial Interface



| Item | Signal | Symbol | Condition | Min | Max | Unit |
|---------------------|--------|--------|-----------|-----|-----|------|
| Serial clock period | SCL | tSCYC | - | 80 | - | ns |
| SCL "H" pulse width | | tSHW | - | 40 | - | |
| SCL "L" pulse width | | tSLW | - | 40 | - | |
| Data setup time | SDA | tSDS | - | 15 | - | |
| Data hold time | | tSDH | - | 20 | - | |
| CSB-SCL time | CSB | tCSS | - | 40 | - | |
| CSB-SCL time | | tCSH | - | 40 | - | |
| CSB "H" pulse width | | tCSW | - | 15 | - | |

Note:

1. The input signal rise and fall time (t_r , t_f) are specified at 15 ns or less.
2. All timing is specified using 20% and 80% of VDDI as the standard.

11. OPTICAL CHARACTERISTIC

| Item | Symbol | Condition. | Min | Typ. | Max. | Unit | Remark | |
|----------------|--------|-----------------------------------|-----|------------|------|-------------------|-------------------|--|
| Response time | T_r | $\theta=0^\circ$ 、 $\phi=0^\circ$ | - | 20 | 30 | .ms | Note 3,5 | |
| | T_f | | - | 10 | 15 | .ms | | |
| Contrast ratio | CR | At optimized viewing angle | - | 800 | - | - | Note 4,5 | |
| Viewing angle | Hor. | $CR \geq 10$ | | 60 | | Deg. | Note 1 | |
| | | | | θ_R | 60 | | | |
| | Ver. | | | θ_L | 60 | | | |
| | | | | ϕ_T | 50 | | | |
| Brightness | - | - | 900 | 1000 | - | cd/m ² | Center of display | |

$T_a=25\pm 2^\circ\text{C}$, $I_L=140\text{mA}$

Note 1: Definition of viewing angle range

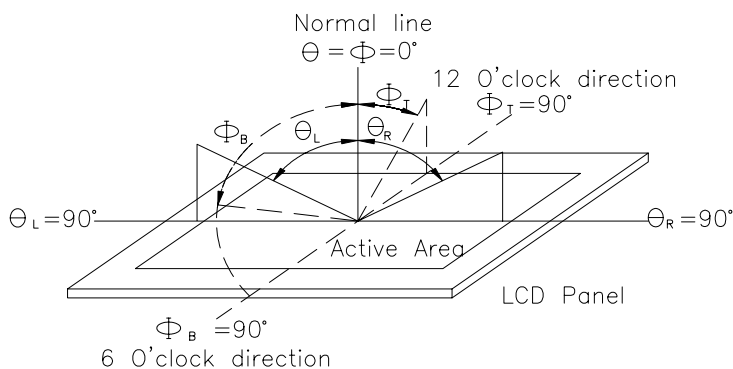


Fig.11.1. Definition of viewing angle

Note 2: Test equipment setup:

After stabilizing and leaving the panel alone at a driven temperature for 10 minutes, the measurement should be executed. Measurement should be executed in a stable, windless, and dark room. Optical specifications are measured by Topcon BM-7 or BM-5 luminance meter 1.0° field of view at a distance of 50cm and normal direction.

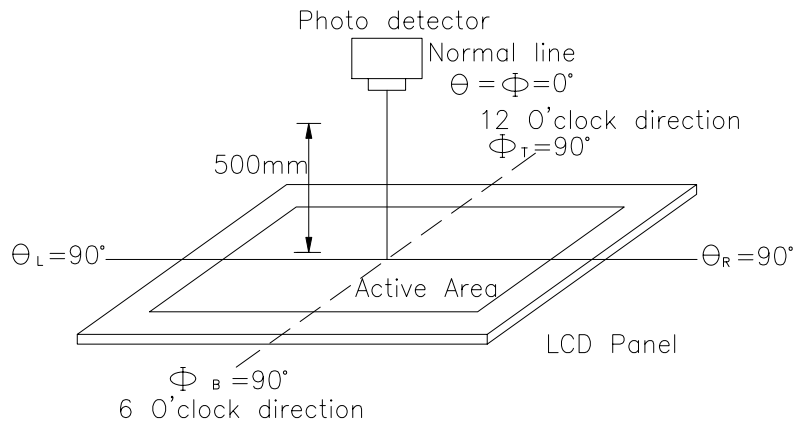
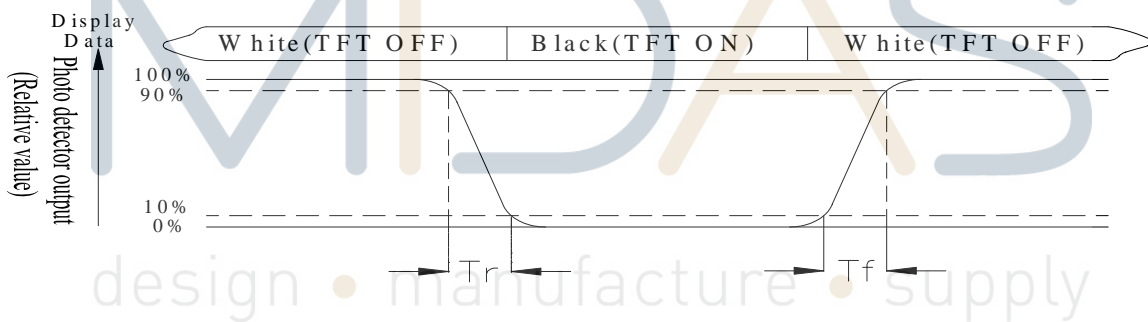


Fig.11.2. Optical measurement system setup

Note 3: Definition of Response time:

The response time is defined as the LCD optical switching time interval between “White” state and “Black” state. Rise time, T_r , is the time between photo detector output intensity changed from 90% to 10%. And fall time, T_f , is the time between photo detector output intensity changed from 10% to 90%



Note 4: Definition of contrast ratio:

The contrast ratio is defined as the following expression.

$$\text{Contrast ratio (CR)} = \frac{\text{Luminance measured when LCD on the "White" state}}{\text{Luminance measured when LCD on the "Black" state}}$$

Note 5: White $V_i = V_{i50} \pm 1.5V$

Black $V_i = V_{i50} \pm 2.0V$

“±” means that the analog input signal swings in phase with VCOM signal.

“±” means that the analog input signal swings out of phase with VCOM signal.

The 100% transmission is defined as the transmission of LCD panel when all the input terminals of module are electrically opened.

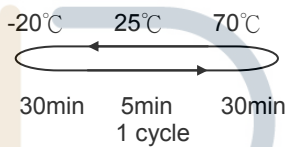
Note 6: Definition of color chromaticity (CIE 1931)

Color coordinates measured at the center point of LCD

Note 7: Measured at the center area of the panel when all the input terminals of LCD panel are electrically opened.

12. Reliability Test

Content of Reliability Test (Wide temperature, -20°C~70°C)

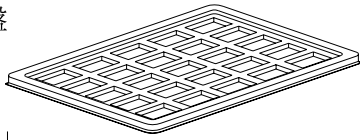
| Environmental Test | | | |
|--------------------------------------|--|---|------|
| Test Item | Content of Test | Test Condition | Note |
| High Temperature storage | Endurance test applying the high storage temperature for a long time. | 80°C 200hrs | 2 |
| Low Temperature storage | Endurance test applying the low storage temperature for a long time. | -30°C 200hrs | 1,2 |
| High Temperature Operation | Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time. | 70°C 200hrs | — |
| Low Temperature Operation | Endurance test applying the electric stress under low temperature for a long time. | -20°C 200hrs | 1 |
| High Temperature/ Humidity Operation | The module should be allowed to stand at 60°C,90%RH max For 96hrs under no-load condition excluding the polarizer, Then taking it out and drying it at normal temperature. | 60°C,90%RH 96hrs | 1,2 |
| Thermal shock resistance | The sample should be allowed stand the following 10 cycles of operation  | -20°C/70°C 10 cycles | — |
| Vibration test | Endurance test applying the vibration during transportation and using. | Total fixed amplitude : 3 15mm Vibration Frequency : 10~55Hz One cycle 60 seconds to 3 directions of X,Y,Z for Each 15 minutes | 3 |
| Static electricity test | Endurance test applying the electric stress to the terminal. | VS=800V,RS=1.5kΩ CS=100pF 1 time | — |

Note1: No dew condensation to be observed.

Note2: The function test shall be conducted after 4 hours storage at the normal Temperature and humidity after remove from the test chamber.

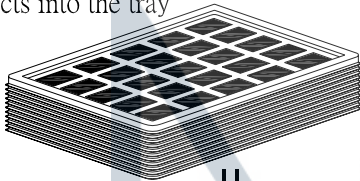
Note3: The packing have to including into the vibration testing.

Use empty tray
空盤

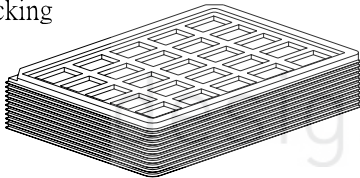


+

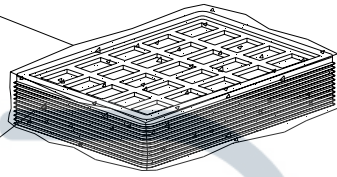
Put products into the tray



Tray stacking



(1) POF

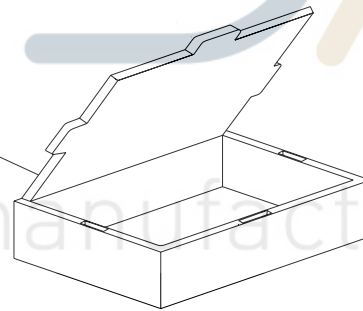


(2) Tray

(4) 泡棉Foam



(3) Product Box



(5) Carton



14.Initial Code For Reference

```
void Initial_code()
{
    Write_Command(0xae);
    Write_Data(0xa5);

    Write_Command(0x61);
    Write_Data(0x8f);
    Write_Data(0x04);
    Write_Data(0xa5);
    Write_Data(0xa5);

    Write_Command(0x62);
    Write_Data(0x36);
    Write_Data(0x0b);
    Write_Data(0x0b);
    Write_Data(0xa5);

    Write_Command(0x33);
    Write_Data(0x07);
    Write_Data(0x2c);
    Write_Data(0x09);
    Write_Data(0x2a);

    Write_Command(0x63);
    Write_Data(0x09);
    Write_Data(0x17);
    Write_Data(0xa5);
    Write_Data(0xa5);

    Write_Command(0x91);
    Write_Data(0x00);
    Write_Data(0x16);
    Write_Data(0x1B);
    Write_Data(0x1C);
    Write_Command(0x92);
    Write_Data(0x1E);
    Write_Data(0x1F);
    Write_Data(0x20);
    Write_Data(0x21);
```

```
Write_Command(0x93);
Write_Data(0x23);
Write_Data(0x24);
Write_Data(0x26);
Write_Data(0x28);
Write_Command(0x94);
Write_Data(0x2B);
Write_Data(0x2F);
Write_Data(0x34);
Write_Data(0x3f);
Write_Command(0x99);
Write_Data(0x00);
Write_Data(0x16);
Write_Data(0x1B);
Write_Data(0x1C);
Write_Command(0x9a);
Write_Data(0x1E);
Write_Data(0x1F);
Write_Data(0x20);
Write_Data(0x21);
Write_Command(0x9b);
Write_Data(0x23);
Write_Data(0x24);
Write_Data(0x26);
Write_Data(0x28);
Write_Command(0x9c);
Write_Data(0x2B);
Write_Data(0x2F);
Write_Data(0x34);
Write_Data(0x3F);
```

```
Write_Command(0x12);
Write_Data(0xa5);
```

```
Write_Command(0x24);
Write_Data(0x01);
Write_Data(0xa5);
Write_Data(0xa5);
Write_Data(0xa5);
```



```
Write_Command(0x22);  
Write_Data(0x00);  
Write_Data(0xa5);  
Write_Data(0xa5);  
Write_Data(0xa5);
```

```
Write_Command(0x15);  
Write_Data(0xa5);
```

```
_nop_();
```

```
}
```

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[MCT101E0CW1280800LMLIPS](#) [MCT104A0W1024768LML](#) [MCT070Z0W800480LML](#) [MCT0144C6W128128PML](#) [MCIB-16-LVDS-](#)
[CABLE](#) [MC41605A6W-FPTLA-V2](#) [MCOT128064UA1V-WM](#) [MCT101E0TW1280800LMLIPS](#) [MCT150B0W1024768LML](#)
[MCT050HDMI-A-RTP](#) [MCT050HDMI-A-CTP](#) [MCT070Z0TW1W800480LML](#) [MCT050ACA0CW800480LML](#) [MC42008A6W-SPTLY](#)
[MC42005A12W-VNMLY](#) [MC42005A12W-VNMLG](#) [MCT052A6W480128LML](#) [MC21605A6WK-BNMLW-V2](#) [MCOT256064A1A-BM](#)
[MCOT22005A1V-EYM](#) [MC20805A12W-VNMLG](#) [MC21605B6WD-BNMLW-V2](#) [MC22405A6WK-BNMLW-V2](#) [MC41605A6WK-](#)
[FPTLW-V2](#) [MCT101HDMI-A-RTP](#) [MCT024L6W240320PML](#) [MCCOG21605D6W-FPTLWI](#) [MC21605A6WD-SPTLY-V2](#)
[MC22005A6WK-BNMLW-V2](#) [MC24005AA6W9-BNMLW-V2](#) [MC42004A6WK-SPTLY-V2](#) [MC11609A6W-SPTLY-V2](#)
[MCOT064048A1V-YM](#) [MCOT128064BY-BM](#) [MCCOG128064B12W-FPTLRGB](#) [MC11609A6W-SPR-V2](#) [MC21605H6WK-BNMLW-V2](#)
[MCOT128064E1V-BM](#) [MCT070HDMI-B-RTP](#) [MDT5000C](#) [MCCOG42005A6W-BNMLWI](#)